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ſ	APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
	10/731,382	12/08/2003	Jean-Charles Souriau	9905/18	4537	
		7590 03/23/200 ER GILSON & LIONE		EXAM	EXAMINER	
	P.O. BOX 10395 CHICAGO, IL 60610			CHIEM, DINH D		
				ART UNIT	PAPER NUMBER	
	•			2883		
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[	SHORTENED STATUTOR	Y PERIOD OF RESPONSE	MAIL DATE	. DELIVERY MODE		
_	3 MO	NTHS	03/23/2007	PAPER		

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

	Application No.	Applicant(s)			
	10/731,382	SOURIAU, JEAN-CHARLES			
Office Action Summary	Examiner	Art Unit			
	Erin D. Chiem	2883			
The MAILING DATE of this communication app Period for Reply					
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).					
Status					
3) Since this application is in condition for allowan					
Disposition of Claims					
4)  Claim(s) 1-23 is/are pending in the application.  4a) Of the above claim(s) 2,3,10-14 and 19-23 is/are withdrawn from consideration.  5)  Claim(s) is/are allowed.  6)  Claim(s) 1,4-9 and 15-18 is/are rejected.  7)  Claim(s) is/are objected to.  8)  Claim(s) are subject to restriction and/or election requirement.  Application Papers  9)  The specification is objected to by the Examiner.  10)  The drawing(s) filed on is/are: a)  accepted or b)  objected to by the Examiner.  Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).					
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  a) All b) Some * c) None of:  1. Certified copies of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No  3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.					
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO/SB/08)  Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	ite			

## **DETAILED ACTION**

This office action is in response to the amendment filed on December 7, 2006. Currently, claims 1-23 are pending, of which claims 2-3, 10-14, and 19-23 are withdrawn from consideration.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1, and 15-18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Moon et al. (US 2004/0023437 A1).

Regarding claim 1, Moon discloses an optical arrangement comprising two parallel plates (100, 200) wherein plate (200) comprises a through-hole defining an optical input with an optical element (203) between the two plates. The first plate (100) of the two plates comprising first fastening studs (204a) placed transversely opposite the first plate and connected by first bumps (208), furthermore, a set of second fastening studs placed transversely opposite the two plates connected by second bumps (102, 110a). The said stud and bumps are known as flip chip bonding wherein the bumps are heated to a reflow temperature and the parallel plates are passive aligned (Para [0046]).

However, Moon does not explicitly disclose a through-hole in both substrates wherein an optical fiber is inserted. It would have been obvious to one having ordinary skill in the art to recognize that the integrated chip "C" with the input fiber (unidirectional device) would be replaceable with another coupling means in which the optical signal can continue to propagate (bi-direction). Therefore, it would have been obvious to one having ordinary skill in the art to recognize that a through-hole may be appropriately placed in the substrate (100) to such that the modified module of Moon would be a bidirectional device.

Regard claims 15-18, Moon discloses the solder bump can be no greater than 100 microns (Para [0028]) between the silicon substrate. Furthermore, the through-hole may be filled with a transparent material (Para [0027]).

Claims 4-9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Moon in view of Mok et al. (US 2005/0026476 A1).

Moon discloses the invention of claim 1, however, Moon is silent in the discussion of the solder pad and solder bump material.

Mok discloses an integrated circuit packaging which utilize flip chip bonding to align optical elements wherein the desirable metals can be nickel alloys, gold alloys or copper alloys (Para [00151]) since these metals are known to have good electrical conductivity. It would have been obvious to one having ordinary skill in the art to recognize the metal used in Mok's flip chip bonding process would be applicable to other flip chip bonded application as well for the named metal have good conductivity.

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## Response to Arguments

Applicant's arguments with respect to claims 1, 4-9, and 15-18 have been considered but are most in view of the new ground(s) of rejection.

## Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, THIS ACTION IS MADE FINAL. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Erin D. Chiem whose telephone number is (571) 272-3102. The examiner can normally be reached on Monday - Thursday 9AM - 5PM.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Frank G. Font can be reached on (571) 272-2415. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Erin D Chiem Examiner Art Unit 2883

Supervisory Primary Examiner Technology Center 2800